CRMKGH0807A

N-Channel 85V, 7.7mΩ Typ. Power MOSFET

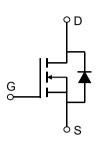
Description

Features

• 85V, 55A

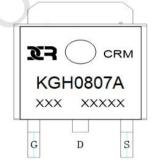
 $R_{DS(ON)}$ Typ = 7.7m Ω @ V_{GS} = 10V

- Advanced Split Gate Trench Technology
- Excellent R_{DS(ON)} and Low Gate Charge
- 100% UIS TESTED!
- 100% ΔVds TESTED!





D



Application

- Load Switch
- PWM Application
- Power Management

Marking and Pin Assignment

Package Marking and Ordering Information

Device	Marking	Package	Outline	Reel Size	Reel (pcs)	Per Carton (pcs)
CRMKGH0807A	CRMKGH0807A	TO-252-3L	TAPING	13"	2500	25000

Absolute Maximum Ratings (@ $T_J = 25^{\circ}C$ unless otherwise specified)

Symbol	Parameter		Value	Units
V_{DS}	Drain-to-Source Voltage		85	V
V_{GS}	Gate-to-Source Voltage		±20	V
	Continuous Drain Current	T _C = 25°C	55	Α
I _D	Continuous Drain Current	$T_{C} = 100^{\circ}C$ 33	33	Α
I _{DM}	Pulsed Drain Current (1)		220	Α
E _{AS}	Single Pulsed Avalanche Energy (2)		90	mJ
P_{D}	Power Dissipation	T _C = 25°C	57	W
$R_{ hetaJC}$	Thermal Resistance, Junction to Case		2.2	°C/W
T_J,T_STG	Junction & Storage Temperature Range		-55 to 150	°C



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Electrical Characteristics (T_J = 25°C unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Off Char	acteristics					
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	85	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 85V, V_{GS} = 0V$	-	-	1.0	μΑ
I _{GSS}	Gate-Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	±100	nA
On Chara	acteristics				6	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2.4	3	3.6	V
R _{DS(ON)}	Static Drain-Source ON-Resistance ⁽³⁾	V _{GS} = 10V, I _D = 20A	-	7.7	10	mΩ
Dynamic	Characteristics					
C _{iss}	Input Capacitance		- /	1136	-	pF
C_{oss}	Output Capacitance	$V_{GS} = 0V, V_{DS} = 40V,$ f = 1MHz	-	391	-	pF
C_{rss}	Reverse Transfer Capacitance	1 - 1101112	X -	15	-	pF
Q_g	Total Gate Charge		-	26	-	nC
Q_{gs}	Gate Source Charge	$V_{GS} = 0 \text{ to } 10V$ $V_{DS} = 40V, I_{D} = 10A$) .	9	-	nC
Q_{gd}	Gate Drain("Miller") Charge	V _{DS} - 40 V, I _D - 10A	-	8	-	nC
Switchin	g Characteristics					
t _{d(on)}	Turn-On DelayTime		-	15	-	ns
t_r	Turn-On Rise Time	$V_{GS} = 10V, V_{DD} = 40V$	-	10	-	ns
$t_{\text{d(off)}}$	Turn-Off DelayTime	I_D = 10A, R_{GEN} = 3Ω	-	30	-	ns
t_f	Turn-Off Fall Time		-	15	-	ns
Drain-So	urce Diode Characteristics and M	Max Ratings				
Is	I _S Maximum Continuous Drain to Source Diode Forward Current			-	55	Α
I _{SM}	Maximum Pulsed Drain to Source Diode	Forward Current	-	-	220	Α
V_{SD}	Drain to Source Diode Forward Voltage	V _{GS} = 0V, I _S = 20A	-	-	1.2	V
trr	Body Diode Reverse Recovery Time	1 404 11/11 4005/	-	50	-	ns
Qrr	Body Diode Reverse Recovery Charge	$I_F = 10A$, di/dt = 100A/us	_	60	_	nC

Notes:

^{1.} Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

^{2.} E_{AS} condition: Starting T_J =25°C, V_{DD} =40V, V_G =10V, R_G =25ohm, L=0.5mH, I_{AS} =19A

^{3.} Pulse Test: Pulse Width $\!\!\!\!<\!300\mu s,$ Duty Cycle $\!\!\!<\!0.5\%.$

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Test Circuit

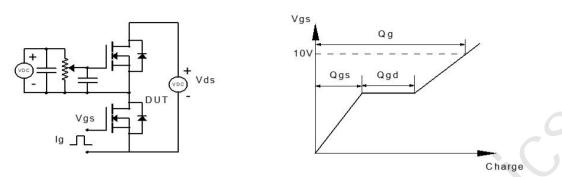


Figure 1: Gate Charge Test Circuit & Waveform

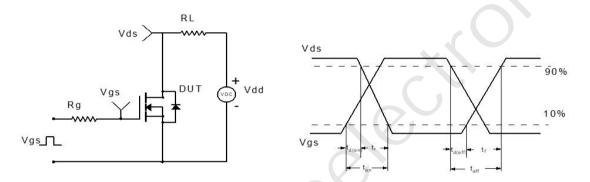


Figure 2: Resistive Switching Test Circuit & Waveform

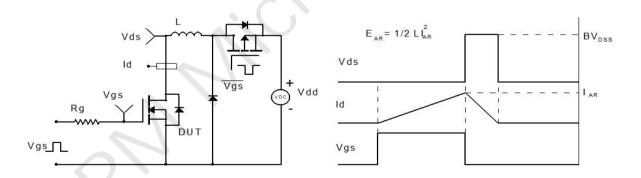


Figure 3: Unclamped Inductive Switching Test Circuit& Waveform

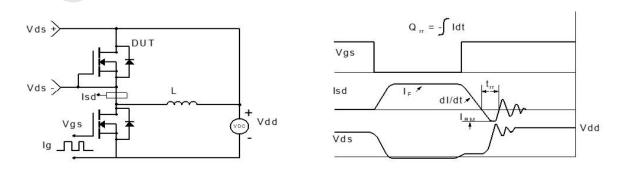
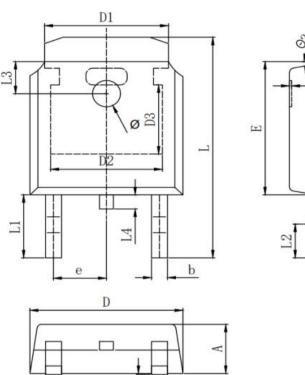


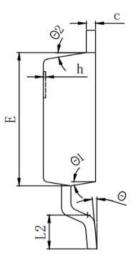
Figure 4: Diode Recovery Test Circuit & Waveform

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Package Mechanical Data(TO-252-3L)





SYMBOL	MILLIMETER					
SIMBUL	MIN Typ.		MAX			
A	2.200	2.300	2. 400			
A1	0.000		0. 127			
b	0.640	0.690	0.740			
(电镀后)	0.460	0.520	0.580			
D	6.500	6.600	6. 700			
D1	5. 334 REF					
D2	4. 826 REF					
D3	3. 166 REF					
E	6.000	6. 100	6. 200			
e	2. 286 TYP					
h	0.000	0.100	0. 200			
L	9. 900	10.100	10.300			
L1	2. 888 REF					
L2	1.400	1.550	1.700			
L3	1.600 REF					
L4	0.600	0.800	1.000			
ф	1.100	1.200	1.300			
θ	0°		8°			
θ 1	9° TYP					
θ2	9° TYP					

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